



Product Change Notification

Change Notification #: 117132 - 00
Change Title: Intel® Ethernet Network Connection
OCP X527-DA4 Product Code
X527DA4OCPG1P5, MM#950127,
PCN 117132-00, Product Design,
FET Update
Date of Publication: August 23, 2019

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	September 15, 2019
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Description of Change to the Customer:

The Intel® Ethernet Network Connection SKU listed in the product affected table below will undergo the following changes:

To optimize the cards ability to read the EEPROM a FET was updated to ensure that it comes up in I2C mode consistently.

As a result of this change, the PBA (printed board assembly) and TA (top assembly) numbers will roll as noted in the affected products table within this PCN notice. If the PBA/TA numbers are printed on any product or box labels, those will show the PBA/TA dash roll as well.

Customer Impact of Change and Recommended Action:

Customers can expect to receive mixed inventory until current inventory levels are depleted. Please contact your local Intel Field Sales Representative if you have any further questions.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
X527DA4OCPG1P5	950127	J44670-002	J16036-005	J44670-003	J16036-006

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
August 23, 2019	00	Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apagccb@intel.com

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